

Bending Actuators Ring Benders

Features

- Free displacement up to +/- 198 μm
- Blocking force up to 41.4 N
- High stiffness for short response times (<1ms)

Applications

- Optical communication
- Valves

- Industrial equipment
- Haptic feedback

Description

CTS tape cast multilayer piezoelectric bending actuators are ideal for a wide range of applications requiring precise and fast movement. CTS multilayer piezo ring benders are produced with a stroke up to +/- 198 μ m and provide higher force than plate benders. The piezo ring benders are used in a wide range of applications due to the robustness and easy integration of a ring.

Standard Product, add-ons or Custom Solution

This document contains information about the CTS standard multilayer ring benders and available add-ons. All the CTS multilayer products can be custom designed to match specific requirements – find more information on www.ctscorp.com or contact your local sales representative.

Move



Specifications

Specifications are given for room temperature use, clamping on 0.5mm wide ring, 0.5mm from the outer edge.

Product	NAC2322	NAC2323	NAC2324	NAC2325	NAC2327	NAC2328	Unit
Outer Diameter (OD)	20 +/- 0.60		30 +/-0.90		40 +/- 1.20		mm
Inner Diameter (ID)	4 +/- 0.15		6 +/- 0.20		8 +/- 0.25		mm
Height (H)	1.25 +/- 0.10	1.8 +/- 0.10	0.7 +/- 0.10	1.25 +/- 0.10	0.7 +/- 0.10	1.25 +/- 0.10	mm
Operating Voltage, V _{max}	200					V	
Free Stroke (+/- 15%)	+/- 28.8	+/- 22	+/- 112	+/-78	+/- 198	+/- 150	μm
Blocking Force, 0 to V _{max} (+/- 20%)	24.2	26.8	13.6	35.0	12.7	41.4	Ν
Capacitance C ₀ (+/- 15%)	2x410	2x620	2x470	2x980	2x820	2x1800	nF
Large Signal Axial Stiffness, typical	0.84	1.22	0.12	0.45	0.06	0.28	N/µm
Unloaded Resonance Frequency, typical	8.0	8.2	3.1	4.2	1.45	2.3	kHz
Maximum Operating Temperature	150						°C
PZT material	NCE51F					-	
External electrodes	Silver					-	







www.ctscorp.com

Page 3 of 8



Add-ons

Wire Options

Two standard wire options are available for ring benders:

		Option A01	Option A02	
	NAC2324, NAC2327	32 AWG MIL-W-16878/6, 7 strands		
Wire type	NAC2322, NAC2323, NAC2325, NAC2328	28 AWG MIL-W-16878/4, 7 strands		
Length		200mm +/-10mm		
Position		Middle of the actuator		
Direction		Perpendicular to the height	Toward the top	

We solder a red wire to the positive electrode, black to the negative and blue to the control terminal.



UHV preparation

Ultra high vacuum (UHV) is the vacuum regime characterized by pressures lower than about 10^{-7} pascal or 100 nanopascals (~ 10^{-9} torr). Extreme cleanliness and low outgassing are essential parameters in sustaining the vacuum level in such systems. Elevated temperature compatibility is often needed since water vapour and other trace gasses are removed from the system during a "bake-out".

CTS piezoceramic components are designed to support system development and integration of piezo technology in UHV applications. Among many technical capabilities, CTS is competent in producing piezoelectric actuators meeting the demands on temperature compatibility and out gassing levels set by UHV operation.

For low outgassing, Kapton-insulated wires are recommended. In addition, with the UHV preparation the products will undergo a specific cleaning process and be packaged in sealed pouches.

Mount and Connect



Storage

We recommend storing piezoelectric ceramic components in a cool and dry environment to avoid tarnishing of the silver electrodes. The ceramic material itself is not affected by humidity, as long as no voltage is applied. If components have been stored in uncontrolled environment, we recommend drying them thoroughly before use. Heat drying is well adapted, for example 24h at 110°C, if possible in low-pressure environment.

Piezoelectric components can be stored for many years without problem. Piezoelectric ceramic is subject to aging from the date of poling, meaning that performance (capacitance, stroke) will decrease slowly according to a logarithmic trend, typically 2-5% per decade (after 1 day, 10 days, 100 days, etc.).

Handling

Piezoelectric ceramic components are fragile and must be handled with care. We recommend to:

- Prevent the components from hitting each other or other hard surfaces, keep components separate
- Particularly for large, thin benders, make sure that no excessive bending stress is induced
- Use plastic tweezers and tools rather than metallic ones
- Use gloves to avoid contamination
- Do not apply excessive force on the pre-attached wires

When submitted to a force or to temperature changes, be aware that piezoelectric components will generate charge (i.e. voltage when in open circuit), and must be properly discharged before use. Always discharge through a resistor rather than shorting the contacts or the wires, as this would create high dynamic forces that can damage the componant.

Cleaning

For the cleaning of ceramic components, we recommend isopropyl-alcohol (propanol) or ethanol. If needed, bending actuators can be fully submerged in solvent. Ensure that the components are dried thoroughly before use.

Mounting

Bending ring actuators may be mounted either by mechanical clamping or using adhesive.

Mechanical clamping

Bending ring actuators offer as-fired top and bottom surfaces and as such may present some unevenness in the surface. For this reason, mechanical clamping should be done a force as low as possible, up to the specified blocking force. In operation, ring benders deform in a slight "bowl" shape, therefore it is very important that the clamping allows tilting of the edge of the component. It is recommended to use a compliant material as counterpart (polymer, GFRP).



RevC_0624

www.ctscorp.com

Page 5 of 8



Bonding with adhesive

Epoxy adhesives are well suited for mounting piezoceramics. For bending actuators, we recommend using a hard (Shore D hardness 70-90), unfilled, non-conductive epoxy. When mounting with adhesive, it should be emphasized that the contact surface must be limited to cover only the inactive part of the bender in order not to reduce its stroke. Precautions include:

- Ensure that the contact surfaces are clean and adequately prepared
- Do not apply excessive clamping force during epoxy cure
- Be aware of stress build-up due to differential thermal expansion when curing at elevated temperature



Driving

Bending actuator rings contain two active sections that share one terminal. Each section can be supplied with a voltage between 0 and 200V to control the bending in a given direction. The overall bending is the combination of the influence of these two sections.



Typical driving schemes are:

www.ctscorp.com

Mount and Connect



Differential voltage control

In this mode, the bending can be controlled both upwards and downwards. Apply +100 V to the positive bias electrode (indicated by the black dot or red wire), -100 V to the negative bias electrode and a voltage V_{in} to the middle electrode such as -100 V < V_{in} <100 V.

- If $V_{in} = 0 V$, both sections see 100 V and compensate each other; the ring remains flat.
- If 0 V< V_{in} <100 V, the ring bends down with the black dot facing up.
- If -100 V< V_{in} <0 V, the ring bends up with the black dot facing up.



Note that if a different voltage reference is used, it is also possible to apply +200 V to the positive bias electrode, 0 V to the negative bias electrode and vary V_{in} between 0 and +200 V.

Single side voltage control

In this mode, the bending can be controlled for one side only, i.e. bending up with the black dot facing up. Only one active section is used, the other section being shorted. Apply 0 V to the negative bias and control electrode connected together, and a voltage between 0 and 200V to the positive bias to control the bending.



Note that it is similarly possible to control the bending in downwards direction by applying 0 V to the negative bias and a control voltage between 0 and 200 V to the positive bias and control electrode connected together.



Bending Actuators Product Families



Learn more about the different bending actuator product families on www.ctscorp.com.